AFETY STANDARDS REGULATED, REINFORCED NSULATION TYPE, AH SERIES	POE-D10-00-E-22	Ver: 22	Page: 1 /
PRODUCT SPE PRODUCT: CERAMIC DISC SAFETY RECOO	CIFICA CAPACITO GNIZED	TI(R	DN
TYPE: <u>AH SERIES</u> CUSTOMER:			
DOC. NO.: POE-D10-00-E-	22		-
			-
APPROVED BY CU	STOMER]
柳城家花饭伤着			
VENDOR : WALSIN TECHNOLOGY CORPORATION 566-1, KAO SHI ROAD, YANG-MEI TAO-YUAN, TAIWAN PAN OVERSEAS (GUANGZHOU) ELECTRONIC CO., NO.277, HONG MING ROAD, EASTERN SECTION, GUANG ZHOU ECONOMIC AND TECHNOLOGY DEVELOPMENT ZONE, CHINA DONGGUAN WALSIN TECHNOLOGY ELECTRONIC NO.638, MEI JING WEST ROAD, XINIUPO, ADMINISTRATIVE ZONE, DALANGTOWN, DONGGUAN CITY, GUANGDONG PROVINC	CS CO., LTD.		- N
MANUFACTURE SITE : PAN OVERSEAS (GUANGZHOU) ELECTRONIC CO.,I NO.277,HONG MING ROAD,EASTERN SECTION, GUANG ZHOU ECONOMIC AND TECHNOLOGY		POElectro	nic POE
DEVELOPMENT ZONE, CHINA			

POE-D10-00-E-22

Page: 2 / 19

Ver: 22

Date	Version	Description	page
2008.6.3	1	1. D22-00-E-01(before) \rightarrow POE-D10-00-E-01(1st edition)	
2008.8.22	2	1. Complete lead code	21
		2. Add last SAP code "H" for halogen and Pb free, epoxy resin	3
2008.12.12	3	1. Complete the 13th to 17th codes of SAP P/N.	4-5
		2. Page layout adjustment.	
2009.7.8	4	1. 1 Change PSA & POE logo to Walsin & POE logo.	
		2. Complete Marking statement.	10
		3. Revised standard NO. of SEV, SEMKO, FIMKO, NEMKO, DEMKO and	12
		KEMA.4. Revised recognized NO. of FIMKO, NEMKO, DEMKO and KEMA.	
2009.9.14	5	 Revised recognized two: of Flyiko, NEWKO, DEWKO and KEWA. H0: 18.0+2.0/-1.5 revised to 18.0+2.0/-0 	9
2009.9.11	5	 "Protrusion length": "+0.5to-1.0" revised to "2.0max (Or the end of lead wire 	9
		may be inside the tape.)"	
		3. 3. Add "250V~" under the "UL" mark according to the product's marking.	10
2009.12.24	6	1. Marking	10
		2. Correct X1 of recognized No by KTL.	11
		3. Revised the Figure of impulse voltage test(Item 7.3.14) according to the standard	14
		IEC 60384-14 ed.3	
0011 1 11	7	4. Add "1AH" code for Y1:400V marking type.	4
2011.1.11	7	1. Review SAP P/N about diameter code: YU*AH561K100*→YU*AH561K080*	6
		 Delete "AT" taping type. Add test item "Temperature Cycle". 	4,5,8,9
		 Add test item Temperature Cycle . Add item 10 "Drawing of internal structure and material list" 	4,3,8,9
		4. Add hell 10 Drawing of internal structure and material list	14
2011.5.12	8	1. Review the safety standards approval and recognized no.	10
	-	2. Delete "old P/N"-	5~6
		3. Add the special marking for P/N:YP*AH102K100	9
2012.1.30	9	1. Review the approval rated voltage of UL and the marking.	8~9
2012/4/6	10	1. In order to improve the traceability of the product, change the date code on	8
		capacitor body, new date code can trace back to production "Lot No."	
		1. Review the Lead diameter φ from 0.60 +0.1/-0.05mm to 0.55+/-0.05mm	5,6,7
		2. Add "3.1Norminal parts & 3.2 special for surge parts" for "3. Part	6
		numbering/T.C/Capacitance/ Tolerance/Diameter" 3. In order the customer to know the round time of manufacture, change the date code	8
2013/5/13	11	on capacitor body, new date code can know the month of manufacture.	0
2013/3/13	11	 Delete "No marked with "_" stand for Pb free". 	
		5. Delete "When the TCC is Y5V(YV), there is a "F" between the "AH" and	8
		capacitance code?"	8
		6. Review the Solderability time from 2 ± 0.5 s to 5 ± 0.5 s	11
		1. Review the "Manufactured Date" to "Products ID" on the marking page	8
2013/10/16	12	2. Delete "The marking can be printed on either one side or two side of coating body.	
2013/10/10	12	"and add "for SAP part number 10-11 digits \leq '07' products" to two sides	8
		and "for SAP part number 11-12 digits \geq '08 products" to one side.	
		1. Review the size of SL*AH820J*** from 080 to be 090.	6
		2. Review the terminal position of the lead wire.	7
		3. Review the product of ID, add the code "D" for the products of Dongguan Walsin	8
2014/11/5	13	 Technology Electronics Co., Ltd. 4. Review the Operating Temperature Range, from "-25 to +125°C" to be "-40 to 	11
		4. Review the Operating Temperature Range, from "-25 to +125°C" to be "-40 to +125°C".	11
		5. Review the minimum packing quantity of taping code AM.	15
		6. Review the low temperature range from -25° C to -40° C for temperature cycle test.	13
		1. Review the Available lead code of Lead Configuration	5
2016/1/27	14	2. Add the SAP P/N :YU*AH681M*.	6
		3. Revised standard NO. of VDE, SEV, SEMKO, FIMKO, NEMKO and DEMKO.	9
		1. Delete 6 Pf~10 Pf for P/N CH*AH***D06 * *, 12 Pf for P/N CH*AH120J06 * *	6
2016/5/3	15	and 15 Pf~27 Pf for P/N CH*AH***J07 * *.	
		2. Add 10 Pf&12 Pf for P/N SL*AH***J06 * *	6

POE-D10-00-E-22

Ver: 22

Page: 3 / 19

		Record of change (continue)	
Date	Version	Description	page
2016/11/3	16	1. Delete "CH" series.	4,6,10~13,18
2017/2/16	17	1. Add "C" code Pitch 12.5mm.	4,5
2017/3/10	18	1. Revise CQC Standard No.	10
2018/8/11	19	1. Revised standard NO. of VDE, SEV, SEMKO, FIMKO, NEMKO and DEMKO.	10
2019/2/25	20	1. Delete "3.2 Special design parts" for surge withstanding	6
2019/4/24	21	 "Protrusion length": "2.0max (Or the end of lead wire may be inside the tape.)" revised to "+0.5to-1.0 (Or the end of lead wire may be inside the tape.)" Add "AS"& "AT" taping type. Add "Soldering Recommendation" 	7~8 8 19
2019/12/11	22	 Review the Available lead code of Lead Configuration Add "8.3 Label samples " 	5 15

Table of Contents

No.	Item	Page
1	Part number for SAP system	4
2	Mechanical	5
3	Part numbering/T.C/Capacitance/ Tolerance/Diameter	6
4	Taping Format	7~8
5	Marking KKWKK 按份本 关	9
6	Scope	10
7	Specification and test method	11~14
8	Packing specification PSA	15
9	Notices	16~17
10	Soldering Recommendation	18
11	Drawing of Internal Structure and material list	19

1. Part number for SAP system:

(Ex.)	YU	0	AH	472	M	13	0	L	20	C	0	H
	(1)	(2)-1	(2)-1	(3)	(4)	(5)	(6)	(7)	(8)	(9)	(10)	(11)

(1)Temperature characteristic (identified code)

CODE	Temperature characteristic	Cap. Change
SL	SL	-1000~+350ppm/°C (+20°C~+85°C)
YP	Y5P	$\pm 10\%$
YU	Y5U	-55% to +20%
YV	Y5V	-80% ~ +30%

(2)-1 Rated voltage(identified by 1-figure code) : $0 = X1:400V \sim /Y1:250V \sim$, $1 = X1:400V \sim /Y1:400V \sim /Y1:40V </V1$

(2)-2 Type(identified by 2-figure code) : AH

(3)Capacitance (identified by 3-figure code):EX.221=220pF

(4)Capacitance tolerance (identified by code): J:±5%,K:±10%,M:±20%

(5)Nominal body diameter dimension (identified by 2-figure code) : 06--Dmax7.0mm, 07--Dmax8.0mm...

(6)Internal code: 0--Normal, other code--Special control

(7)Lead Style : Refer to "2. Mechanical".

(8)Packing mode and lead length (identified by 2-figure code)

Taping Code	Description
AM	Ammo box and product pitch : 25.4 mm
AS	Ammo box and product pitch : 15.0 mm (Only for the SAP part number 11-12 digits ≤ 11)
AT	Ammo box and product pitch : 30.0 mm
Bulk Code	Description

Bulk Code	Description
03	Lead length : PA3.0mm SYSTEM ALLIANCE
3E	Lead length : 3.5mm
04	Lead length : 4.0mm
4E	Lead length : 4.5mm
20	Lead length : 20mm

(9)Length tolerance

Code	Description	1101
А	±0.5 mm	Short lead
	(only for kink lead type)	Short leau
В	±1.0 mm	Short lead
С	Min.	Long lead
D	Taping special purpose	Taping

(10)Pitch

Code	Description
0	10±1 mm
А	10±0.5 mm
С	$12.5 \pm 0.8 \text{ mm}$

(11)Epoxy Resin Code

Code	Description
В	Helegen and Dh free energy regin
Н	Halogen and Pb free, epoxy resin.

POE-D10-00-E-22 Ver: 22

Page: 5 / 19

2. Mechanical:

Encapsulation : Epoxy resin, flammability UL94 V-0

Available lead code (unit: mm):

Lead type	SAP P/N (13-17)digits	Pitch (F)	Lead Length (L)	Packing	Lead Configuration			
	L03B0	10 ± 1.0	(L) 3.0 ± 1.0					
	L03B0 L4EB0	10 ± 1.0 10 ± 1.0	3.0 ± 1.0 4.5 ± 1.0					
	L05B0	10 ± 1.0 10 ± 1.0	5.0 ± 1.0		D max. T max.			
	L03BC	12.5 ± 0.8	3.0 ± 1.0	D 11				
Lead style : L or B	L4EBC	12.5 ± 0.8 12.5 ± 0.8	3.0 ± 1.0 4.5 ± 1.0	Bulk	() For			
Type L or B	L4EBC L05BC	12.5 ± 0.8 12.5 ± 0.8	4.5 ± 1.0 5.0 ± 1.0		L≧20mm			
Straight lead	L20C0	12.5 ± 0.8 10 ± 1.0	20 min.					
	L20CC	10 ± 1.0 12.5 ± 0.8	20 min.		For			
	BAMD0	12.3 ± 0.8 10 ± 1.0	20 11111.		L<20mm			
	BAND0 BASD0	10 ± 1.0 10 ± 1.0	Refer to "4. Taping	Tap. Ammo				
			format"	Tap. Animo				
	BATD0	10 ± 1.0						
	G03B0	10 ± 1.0	3.0 ± 1.0					
	G4EB0	10 ± 1.0	4.5 ± 1.0	Bulk				
Lead style : G Type G Straight lead	G05B0	10 ± 1.0	F5.0±1.0					
	GAMD0	10 ± 1.0	、该股份者					
	GASD0	10 ± 1.0	Refer to "4. Taping format"	Tap. Ammo				
	GATD0	10 ± 1.0						
	D03A0	10 ± 1.0	3.0 ± 0.5					
	D3EA0	90 ± 1.0	3.5 ± 0.5		D max. T max.			
	D04A0	10 ± 1.0	4.0 ± 0.5					
Lead style : D	D03AC	12.5 ± 0.8	3.0 ± 0.5	Bulk				
Type D	D3EAC	12.5 ± 0.8	3.5 ± 0.5					
Vertical kink	D04AC	12.5 ± 0.8	4.0 ± 0.5	an All the				
lead	DAMD0	10 ± 1.0	Refer to "4. Taping	1011.				
	DASD0	10 ± 1.0	Refer to "4. Taping format"	Tap. Ammo	ød+l+ <u> </u>			
	DATD0	10 ± 1.0	Tormat					
	X03A0	10 ± 1.0	3.0 ± 0.5		D max. T max.			
	X3EA0	10 ± 1.0	3.5 ± 0.5					
	X04A0	10 ± 1.0	4.0 ± 0.5					
· · · · · · · · ·	X05B0	10 ± 1.0	5.0 ± 1.0	D11-				
Lead style : X	X03AC	12.5 ± 0.8	3.0 ± 0.5	Bulk				
Type X	X3EAC	12.5 ± 0.8	3.5 ± 0.5					
Outside kink lead	X04AC	12.5 ± 0.8	4.0 ± 0.5		<u>≣</u> H A			
	X05BC	12.5 ± 0.8	5.0 ± 1.0					
	XAMD0	10 ± 1.0	Refer to "4. Taping	Tap. Ammo				
	XATD0	10 ± 1.0	format"	14p. 7 mmo	и и <u>и+</u>			

* Lead diameter Φd: 0.55 +/-0.05mm

*e (Coating extension on leads): 3.0mm Max for straight lead style, not exceed the kink for kink lead.

POE-D10-00-E-22 Ver: 22

Page: 6 / 19

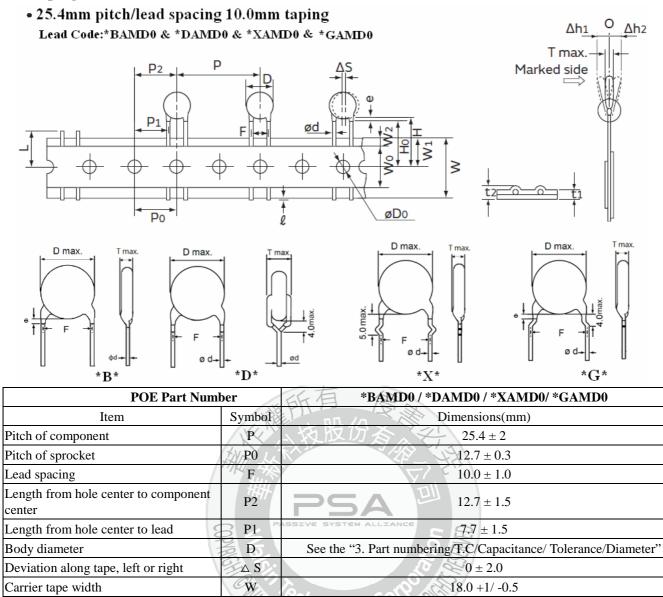
3. Part numbering/T.C/Capacitance/ Tolerance/Diameter :

SAP P/N	T.C.	Capacitance(pF)	Tolerance		Dimens	sion (unit:mm)	
SAI 1/IN	1.C.	Capacitanec(pr)	Tolerance	D(max.)	T(max.)	F	Φd
SL*AH***J060*		10,12,15,18,20,22,24, 27,30,33, 36, 39(pF)		7.0			
SL*AH***J070*	SL*	47,50,51, 56,62(pF)	$\pm 5\%$	8.0			
SL*AH***J080*		68,75(pF)		9.0			
SL*AH***J090*		82,100(pF)		10.0			
YP*AH101K060*		100 pF		7.0			
YP*AH151K060*		150 pF		7.0	5.0	10±1	0.55+/-0.05
YP*AH221K060*	-	220 pF	±10%	7.0			
YP*AH331K060*		330 pF		7.0			
YP*AH471K070*		470 pF		8.0			
YP*AH561K080*		560 pF		9.0			
YP*AH681K080*		680 pF		9.0			
YP*AH102K100*		1000 pF		11.0			
YU*AH681M060*		680 pF		7.0			
YU*AH102M070*		1000 pF		8.0			
YU*AH152M080*		1500 pF		9.0			
YU*AH222M090*	Y5U	2200 pF		10.0	5.0		
YU*AH332M110*		3300 pF		12.0			
YU*AH392M120*		3900 pF	±20%	13.0		10±1	0.55+/-0.05
YU*AH472M130*]	4700 pF	12070	14.0		10±1	0.5517-0.05
YV*AH102M060*		1000pF		7.0			
YV*AH152M070*		1500pF	方	8.0			
YV*AH222M080*	Y5V	2200pF	TA :	9.0	5.5		
YV*AH332M100*		3300pF	七阳公	11.0	1		
YV*AH472M110*		4700pF	这区历	12.0	T		

• The minimum thickness of coating (reinforced insulation) is 0.4mm.



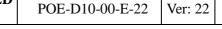
4. Taping Format:



Ver: 22

Page: 7 / 19

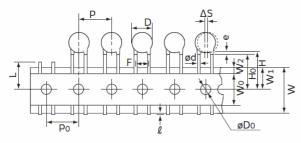
Body diameter	PP	See the "3. Part numbering/1.C/Capacitance/ Tolerance/Diameter"
Deviation along tape, left or right	ΔS	0 ± 2.0
Carrier tape width	W	18.0 +1/ -0.5
Position of sprocket hole	W1	9.0 ± 0.5
Lead distance between the kink and center of sprocket hole	Н0	18.0 +2.0/-0 (For: *DAMD0 & *XAMD0 & *GAMD0)
Lead distance between the bottom of body and the center of sprocket hole	Н	20.0+1.5/-1.0 (For: *BAMD0)
Length from the terminal of the lead wire to the edge of carrier tape	l	+0.5 to -1.0 (or the end of lead wire may be inside the hole-down tape.)
Diameter of sprocket hole	D0	4.0 ± 0.2
Lead diameter	φd	0.55 ± 0.05
Total tape thickness	t1	0.6 ± 0.3
Total thickness, tape and lead wire	t2	1.5 max.
Deviation across tand	\triangle h1	2.0 max.
Deviation across tape	\triangle h2	2.0 max
Portion to cut in case of defect	L	11.0 max.
Hole-down tape width	W0	8.0 min
Hole-down tape distortion	W2	1.5 ± 1.5
Coating extension on leads	e	3.0mm max for straight lead style; Not exceed the kink leads for kink lead.
Body thickness	Т	See the "3. Part numbering/T.C/Capacitance/ Tolerance/Diameter"

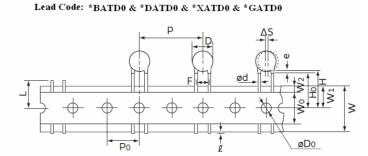


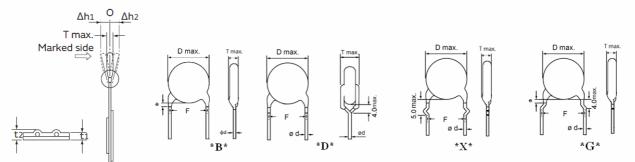
• 30mm pitch/lead spacing 10.0mm taping

r: 22 Page: 8 / 19

•15mm pitch/lead spacing 10.0mm taping Lead Code: *BASD0 & *DASD0 & *GASD0







POE Part Numbe	r	*BASD0/*DASD0/*GASD0	*BATD0/*DATD0 /*GATD0/*XATD0	
Item	Symbol _	Dimensions(mm)		
Pitch of component	HEPPITA	15.0±1	30.0 ± 2	
Pitch of sprocket	P0	沿公 1	5.0±0.3	
Lead spacing			0.0±1.0	
Body diameter	D	See the "3. Part numbering/T.	C/Capacitance/ Tolerance/Diameter"	
Deviation along tape, left or right	## △ S		0 ± 2.0	
Carrier tape width	W	BA 18.	0 +1/ -0.5	
Position of sprocket hole	W1	YSTEM ALLIANCE	0.0 ± 0.5	
Lead distance between the kink and center of sprocket hole	HO	18.0 +2.0/-0 (For: *DASD0 & *GASD0)	18.0 +2.0/-0 (For: *DATD0 & *GATD0 & *XATD0)	
Lead distance between the bottom of body and the center of sprocket hole	HSW HChn	20.0+1.5/-1.0 (For: *BASD0)	20.0+1.5/-1.0 (For: *BATD0)	
Length from the terminal of the lead wire to the edge of carrier tape	l'ANOLO	+0.5 to $+1.0$ (or the end of lea	d wire may be inside the hole-down tape.)	
Diameter of sprocket hole	D0	4	$.0 \pm 0.2$	
Lead diameter	φd	0.	55 ±0.05	
Total tape thickness	t1	0	0.6 ± 0.3	
Total thickness, tape and lead wire	t2	1	.5 max.	
Deviation across tape	\triangle h1/ \triangle h2	2	2.0 max.	
Portion to cut in case of defect	L	1	1.0 max.	
Hole-down tape width	W0	8	8.0 min	
Hole-down tape distortion	W2	1	.5 ± 1.5	
Coating extension on leads	e	3.0 max for straight lead style; Not exceed the kink leads for kink lead.		
Body thickness	Т	See the "3. Part numbering/T.	C/Capacitance/ Tolerance/Diameter"	

POE-D10-00-E-22 Ver: 22 Page: 9 / 19

PSA

5. Marking:

1.Type Designation	AH					
2.Nominal Capacitance	Identified by 3-Figure Code. Ex. 47	7pF → "4′	7",470pF → "471"			
3.Capacitance Tolerance	J:±5%,K:±10%,M:±20%					
4.Company Name Code(Trade mark)	UK					
5. Products ID	Abbreviation ex.: Manufacture year: ← 9 C 6 1234 - 9:2019 0:2020 1:2021 ↓ Epoxy resin co Manufactory: "_": Haglogen free epoxy (Guangzhou) (For the la "H" and " SAP P/N)	→ Individ ode: and Pb y resin st code	Last 4 digits of lot no. dual specification code Manufacture month: 1:January 2:Feruary : 9:September 0:October N:November D:December			
6.Approved Monogram:						
(1) VDE approval mark	IEC 60384-14 Class Code : X1 : 400V	~ , Y1 :	250V~ or 400V~			
2) UL approval mark	(6) DEMKO approval ma	D				
(3) CSA approval mark	CSA approval mark (7) FIMKO approval mar					
(4) SEMKO approval mark	(8) SEV approval mark	EV approval mark				
(5) NEMKO approval mark	(9) CQC approval mark					
	marking		P*AH102K***** pecial marking)			
$digits \leq "07" \text{ products})$ (K) (K) $(H101K)$ $(DAH:)$ $(H101K)$ $(H100K)$ $(H100K)$ $(H100K)$ $(H100K)$ $(H100K)$ $(H1$	One side (for SAP part number 10-11 digits ≥ "08" products) OAH: 1AH: UK UK	0AH	UK AH102K W 250V~ W Y1:250V~ W 9 <u>C</u> 61234			
UK AH101K (D) (E) (N)	$\begin{array}{c} \textbf{AH472M} \\ \textcircled{0}{} \textbf{b}{} \textbf{E} \\ (\textbf{b}{} \textbf{E} \\ \textbf{b}{} \textbf{C} \\ \textbf{b}{} \textbf{E} \\ \textbf{b}{} \textbf{c} \\ \textbf{b}{} \textbf{E} \\ \textbf{b}{} \textbf{c} \\ c$	1AH	UK AH102K 10 9 1 : 400V~ 1 : 400V~ 1 : 400V~			
1AH: BU X1:400V- Y1:400V- 9 <u>C</u> 61234			9 <u>C</u> 61 <u>2</u> 34			
Al x1:400V- Y1:400V- 9C61234 * Marking by the laser.	tand for Halogen and Pb free epoxy r		9 <u>C</u> 61234			

SAFETY STANDARDS REGULATED, REINFORCED INSULATION TYPE, AH SERIES	POE-D10-00-E-22	Ver: 22	Page: 10 / 19

6. Scope:

THIS SPECIFICATION APPLIES TO CERAMIC INSULATED CAPACITORS DISK TYPE USED IN ELECTRONIC EQUIPMENT.

6.1Applicable safety standard

This specification applies to the VDE, SEV, SEMKO, FIMKO, NEMKO, DEMKO, KTL, UL, CSA approved ceramic capacitors disc type for antenna coupling, line-by-pass and across-the-line. X1, Y1 capacitor based on IEC60384-14. "UL, CSA recognized capacitor for across-the-line, line-by-pass" and antenna-isolation.

6.2 Safety standards approval and recognized no.

Safety Standard	Standard No.	Subclass	w.v.	Recognized No.
UL	ANSI/UL 60384-14:2013	X1	400VAC	E146544
OL	ANSI/02 00304-14.2013	Y1	250VAC/400VAC	L140544
CSA	IEC60384-14 (ed.4) 2013	X1	400VAC	2347971
CON		Y1	250VAC/400VAC	2311911
VDE	EN 60384-14:2013/A1:2016	X1	400VAC	10001001
(ENEC)	IEC 6.384-14:2013 IEC 6.384-14:2013/AMD1:2016	Y1	250VAC/400VAC	40001804
SEV	EN 60384-14:2013 + A1:16	X1	400VAC	18.0652
SEV	EN 60364-14.2013 + A1.16	Y1	250VAC/400VAC	18.0032
SEMKO	EN 60384-14:2013+A1	X1	400VAC	1811992
SLWIKO		Y1	250VAC/400VAC	1011/)2
FIMKO	EN 60384-14:2013 + A1:16	\mathcal{Y}_{X1}	400VAC	NCS/FI 30462
FINIKO	EN 00384-14.2013 + A1.10	Y1	250VAC/400VAC	NCS/FI 50402
NEMKO	EN 60384-14:2013;A1	X1	400VAC	No. P18222946
		Y1	250VAC/400VAC	10.110222940
DEMKO	EN 60384-14:2013/A1:2016	X1	400VAC	D-07609
DEWIKO	EN 60384-14:2013	Y1	250VAC/400VAC	D-07009
CQC	IEC60384-14:2013+AMDI:2016	X1:400	OVAC/Y1:400VAC	CQC03001003673
ιųι	GB/T6346.14-2015	700X1:400	VAC/Y1:250VAC	CQC11001055510
	KC60384-1(2015-09)	nox topon	400VAC	SU03065-14004A
KTL	KC60384-14(2015-09)	YIUMU	250VAC	SU03065-14005A
	IEC 60384-14(ed.3)	Y1	400VAC	SU03065-14006A

POE-D10-00-E-22

Ver: 22

7. Specification and test method:

7.1 Operating Temperature Range: -40 to +125°C

7.2 Test condition:

Test and measurement shall be made at the standard condition. (temperature $15 \sim 35^{\circ}$ C, relative humidity $45 \sim 75^{\circ}$ and atmospheric pressure $860 \sim 1060$ hpa). Unless otherwise specified herein.

If doubt occurred on the value of measurement, and measurement was requested by customer capacitors shall be measured at the reference condition. (temperature $20\pm2^{\circ}$ C or $25\pm2^{\circ}$ C, relative humidity 60~70% and atmospheric pressure 860~1060hpa.)

7.3 Performance:

No	It	ems	Performance	Testing method				
7.3.1		earance imension	No visible defect, and dimensions are within specified range.	The capacitor should be visually inspected for evidence of defect. Dimensions should be measured with slide calipers.				
7.3.2	Ma	rking	To be easily legible.	The capacitor should be visually inspected.				
		Between terminals	No failure.	The capacitor should be visually inspected. The capacitors shall not be damage when AC4000V (rms.) are applied between the lead wires for 60sec. (Charge/Discharge current \leq 50mA.)				
7.3.3	Dielectric Strength	Body Insulation	No failure. 任權所有乃	First, the terminals of the capacitor should be connected together. Then, a metal foil should be closely wrapped around the body of the capacitor to the distance of about 3 to 6mm from each terminal. Then, the capacitor should be inserted into a container filled w metal balls of about 1mm diameter. Finally, AC4000V (r.m.s.)<50/60Hz> is applied for 60 s between the capacitor lead wires and metal balls. (Charge/Discharge current \leq 50mA.) The insulation resistance shall be measured with				
7.3.4	Insulation Resistance	Between terminals	$10000M\Omega$ or more.	The insulation resistance shall be measured with DC500±50V within 60±5sec of charging.				
7.3.5	Capacitance		Within specified tolerance.	Y5P&Y5U&Y5V: The capacitance should be measured at 20°C with 1±0.2kHz and AC5V(r.m.s.) max. SL: The capacitance shall be measured at 25°C with 1MHz±20% and1.0±0.2Vrms				
7.3.6	Dissipation Factor(tanδ) or Q		Y5P \cdot Y5U : D.F. $\leq 2.5\%$ Y5V : D.F. $\leq 5.0\%$ SL : 30pF&above: ≥ 1000 Below 30PF: $\geq 400+20\times C$					
	Temperature Characteristic		Char. Capacitance Change Y5P Within ± 10%	The capacitance measurement shall be made at each step specified in Table 1.				
			Y5U Within $\pm_{55}^{20}\%$	Step 1 2 3 4 5				
7.3.7			Y5V Within $-80 \sim +30\%$ $-1000 \sim +350$ SL ppm/°C (20°C) $05°C$	Temp.($^{\circ}$ C) +20±2 -25±2 +20±2 +85±2 +20±2 Pre-treatment:				
			(+20°C ~+85°C)	Capacitor shall be stored at $125\pm2^{\circ}$ C for 1hour, then placed at ^{*1} room condition for 24±2hours before measurements.				
7.3.8	Solderability of Leads		Lead wire should be soldered with uniform coating on the axial direction over 3/4 of the circumferential direction.	The lead wire of capacitor should be dipped into molten solder for 5 ± 0.5 sec. The depth of immersion is up to about 1.5 to 2.0 mm from the root of lead wires. Temp. of solder : Lead Free Solder (Sn-3Ag-0.5Cu) 245 \pm 5°C				

* "room condition" temperature : 15~35°C, humidity : 45~75%, atmospheric pressure : 86~106kPa

* "C" expresses nominal capacitance value (pF).

POE-D10-00-E-22

Ver: 22	Page: 12	2 / 19

No	Iten	15	Performance	Testing method		
		Tensile	Lead wire shall not cut off capacitor shall not be broken.	As shown in the figure at right, fix the body of the capacitor and apply a tensile weight gradually to each lead wire in the radial direction of the capacitor up to 10N and keep it for 10±1 sec.		
7.3.9	7.3.9 Robustness of Terminations	Bending	Lead wire shall not cut off. Capacitor shall not be broken.	With the termination in its normal position, the specimen held by its body in such a manner that the axis of t termination is vertical; a mass applying a force of 5N is th suspended from the end of the termination. The body of specimen is then inclined, within a period of 2 to 3s through an angle of approximately 90° in the vertical pla and then returned to its initial position over the same perio of time; this operation constitutes one bend. One be immediately followed by a second bend in the oppose direction.		
		Appearance	No marked defect.	As shown in figure, the lead wires should be immersed in solder of 350 ± 10 °C or 260 ± 5 °C up to 1.5 to 2.0 mm from		
		I.R.	1000 MΩ min.	the root of terminal for 3.5 ± 0.5 sec (10 ± 1 sec. for 260 ± 5 °C).		
		Dielectric Strength	Per item7.3. 3	Thermal Capacitor		
7.3.10	7.3.10 Soldering Effect (Non-Preheat)	Capacitance Change	Y5P,Y5U,Y5V : Within ±10 % SL.: Within±2.5% or ±0.25pF,Whichever is large.	Pre-treatment: Capacitor shall be stored at 125±2°C for 1hour.then placed at *1room condition for 24±2hours before initial measurements. Post-treatment: Capacitor shall be stored for 1 to 2hours at *1room condition.		
		Appearance	No marked defect.	First the capacitor should be stored at $120+0/-5$ °C for 60 +0/-5 sec. Then , as in figure , the lead wires should be immersed solder of 260+0/-5 °C up to 1.5 to 2.0 mm from the root of terminal for 7.5+0/-1 sec. Thermal Screen, 1.5 1.5 1.5 1.5 1.5 1.5 1.5		
7.3.11	7 2 11 Soldering	I.R.	1000 MΩ min.	L () Molten		
(On-Preheat)	Effect (On-Preheat)	Dielectric Strength	Per item 7.3.3	Solder		
	Capacitance Change	Y5P,Y5U,Y5V : Within ±10 % SL : Within±2.5% or ±0.25pF,Whichever is large.	Pre-treatment: Capacitor shall be stored at 125±2°C for 1hour.then placed at ^{* 1} room condition for 24±2hours before initial measurements. Post-treatment: Capacitor shall be stored for 1 to 2hours at ^{* 1} room condition.			

* "room condition" temperature : 15~35°C, humidity : 45~75%, atmospheric pressure : 86~106kPa

* "C" expresses nominal capacitance value (pF).

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Ver: 22	Page:	13	/	19	

No	Iter	ns	Performance	Testing method		
7.3.12	Humidity (Under steady State)	Appearance Capacitance Change	No marked defect. Y5P: Within $\pm 10\%$ Y5U: Within $\pm 20\%$ Y5V: Within $\pm 30\%$ SL: Within $\pm 2.5\%$ or $\pm 0.25pF$, Whichever is large.	Set the capacitor for 500±12hours at 40±2°C in 90 to 959 relative humidity. Then capacitor shall be stored for 1 to 2 hours at ^{* 1} room condition. Pre-treatment: Capacitor shall be stored at 125±2°C for 1hour.then		
		D.F. Q	Y5P,Y5U : 5.0% max. Y5V : 7.5% max. SL : Q≧100+10×C/3 (C<30pF)	placed at ^{*1} room condition for 24±2hours. Post-treatment: Capacitor shall be stored for 1 to 2hours at ^{*1} room condition.		
7.3.13	Humidity Loading	I.R. Dielectric Strength	$Q \ge 200 (C \ge 30 \text{pF})$ $Y5P \& Y5U \& Y5V :$ $3000 M\Omega \text{ min.}$ $SL : 1000 M\Omega \text{ min.}$ Per Item 7.3.3	Apply the rated voltage for 500 ± 12 hours at $40\pm2^{\circ}$ C i 90 to 95% relative humidity Pre-treatment: Capacitor shall be stored at $125\pm2^{\circ}$ C for 1hour.then placed at ^{*1} room condition for 24 ± 2 hours. Post-treatment: Capacitor shall be stored for 1 to 2hours at ^{*1} roor condition. Impulse Voltage Each individual capacitor shall be subjected to 8kV impulses for three times. After the capacitors are applied to life test. Vp 0.9Vp 0.9Vp 1.2 46 0.1 1.5 47 Time The specimen capacitors are placed in a circulating air oven for a period of 1000 hours. The air in the oven is maintained at a temperature of $125\pm3^{\circ}$ C. Throughout the test, the capacitors are subjected to an AC425Vrms.(for 0AH type) or AC680Vrms.(for 1AH type) alternating voltage of mains frequency, except that once each hour the voltage is increased to AC1000V(rms.) for 0.1 sec. Pre-treatment: Capacitor shall be stored at $125\pm2^{\circ}$ C for 1hour.then placed at ^{*1} room condition for 24 ± 2 hours. Post-treatment: Capacitor shall be stored for 1 to 2hours at ^{*1} room condition.		
7.3.14	Life	Appearance Capacitance Change I.R. Dielectric Strength	No marked defect. Y5P&Y5U&Y5V : Within $\pm 20\%$ SL : Within $\pm 3\%$ or ± 0.3 pF, Whichever is large. 3000M Ω min. SL : 1000M Ω min. SL : 1000M Ω min. PASSIVE SYSTEM ALL PASSIVE SYSTEM ALL			

 $\label{eq:condition} \mbox{``room condition'' temperature $$: 15~35^{\circ}C$, humidity $$: 45~75\%$, atmospheric pressure $$: 86~106kPa$ }$

* "C" expresses nominal capacitance value (pF).

No		Items	Performance	Testing method	
7.3.15		Active mmability	The cheesecloth shall not be on fire.	The specimens shall be individually wrapped in at least one but more than two complete layers of cheesecloth. The specimens shall be subjected to 20 discharges. The interval between successive discharges shall be 5 sec. The UAC shall be maintained for 2 min after the last discharge. $\underbrace{I_{1}}_{T_{r}} \underbrace{I_{2}}_{UAC} \underbrace{I_{2}}_{UC} \underbrace$	
7.3.16	Passive Flammability not be executive for the ex		The burning time shall not be exceeded the time 30 sec. The tissue paper shall not ignite.	The capacitor under test shall be held in the position which best promotes burning. Each specimen shall only be exposed once to flame. Time of exposure to flame: 30sec. Length of flame : 12±1mm Gas burner : Length 35mm min. Inside Dia. : 0.5±0.1mm Outside Dia. : 0.9mm max. Gas : Butane gas Purity 95% min. Gas : Butane gas Purity 95% min.	
	Temperat ure Cycle	Appearance	No marked defect	The capacitor should be subjected to 5 temperature cycles,	
		Char. Cap. Change	DF / Q	<temperature 5cycles="" cycle="" time:=""> Step Temperature(°C) Time(min) 1 -40+0/-3 30</temperature>	
			$Q \ge 275 + 5/2C (C < 30pF)$ $Q \ge 350 (C \ge 30pF)$	2 Room temp. 3 3 125+3/-0 30	
		$Y5P \leq \pm 10\% I$	$DF \leq 5.0\%$	4 Room temp. 3	
I \		$\left \begin{smallmatrix} Y5U \\ Y5V \end{smallmatrix} ight \leq \pm 20\% ~~I$	DF≦7.5%	Pre-treatment: Capacitor shall be stored at 125±2°C for 1hour.then placed at [*] ¹ room condition for 24±2hours.	
				Post-treatment: Capacitor shall be stored for 1 to 2hours at $*^{1}$ room condition.	
		I.R.	3000MΩ min.	Post-treatment:	

☆ "room condition" temperature : 15~35°C, humidity : 45~75%, atmospheric pressure : 86~106kPa

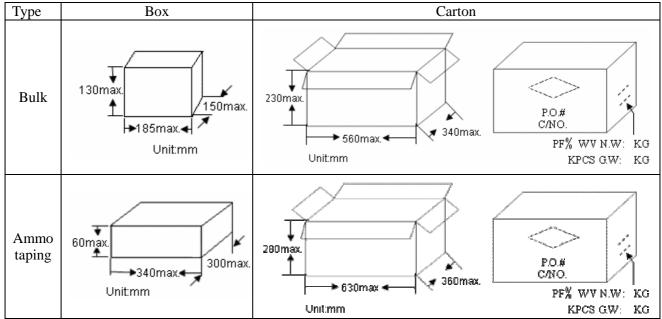
* "C" expresses nominal capacitance value (pF).

POE-D10-00-E-22 Ver: 22

2 Page: 15 / 19

8.Packing Baggage :

8.1 Packing size:



8.2 Packing quantity:

Packing type	The code of 14th to15th in SAP P/N	MPQ (Kpcs/Box)
	AM (The size code ≤ 11)	1
Toping	AM (The size code \geq 12)	0.5
Taping	AS F- F	1
	AT AT	0.5

PSA

Packing type	Lead length	Size code of 10th to 11th in SAP P/N	MPQ (Kpcs/Bag)	Kpcs/Box
	Long lead (L≧20mm)	06~12	0.5	1.5
	$(L \ge 20 \text{mm})$	13-15	0.5	1
Bulk	Short lead	Shn 06~14	0.5	2
	(L<20mm)	ECHNOLOGY ASROBATION.	0.2	1
	All	16	0.2	1

8.3 Label samples



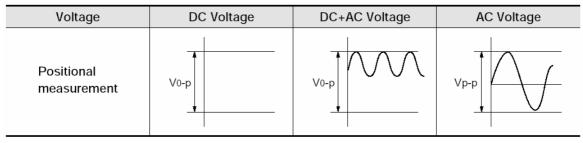
9. Notices:

9.1 Caution (Rating):

(1). Operating Voltage

Be sure to maintain the Vp-p value of the applied voltage or the Vo-p which contains DC bias within the rated voltage range.

When the voltage is started to apply to the circuit or it is stopped applying, the irregular voltage may be generated for a transit period because of resonance or switching. Be sure to use a capacitor within rated voltage containing this irregular voltage.



(2). Operating Temperature and Self-generated Heat

Keep the surface temperature of a capacitor below the upper limit of its rated operating temperature range. Be sure to take into account the heat generated by the capacitor itself.

- (3). Test condition for withstanding Voltage
 - I. Test Equipment

Test equipment for AC withstanding voltage shall be used with the performance of the wave similar to 50/60 Hz sine waves.

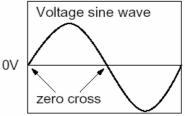
If the distorted sine wave or over load exceeding the specified voltage value is applied, the defective may be caused.

II. Voltage Applied Method

When the withstanding voltage is applied, capacitor's lead or terminal shall be firmly connected to the output of the withstanding voltage test equipment, and then the voltage shall be raised from near zero to the test voltage.

If the test voltage without the raise from near zero voltage would be applied directly to capacitor, test voltage should be applied with the *zero cross. At the end of the test time, the test voltage shall be reduced to near zero, and then capacitor's lead or terminal shall be taken off the output of the withstanding voltage test equipment.

If the test voltage without the raise from near zero voltage would be applied directly to capacitor, the surge voltage may arise, and therefore, the defective may be caused.



ZERO CROSS is the point where voltage sine wave pass 0V.- See the right figure.

(4). Fail-Safe

When capacitor would be broken, failure may result in a short circuit. Be sure to provide an appropriate fail-safe function like a fuse on your product if failure would follow an electric shock, fire or fume.

Ver: 22

Page: 17 / 19

Failure to follow the above cautions may result, worst case, in a short circuit and cause fuming or partial dispersion when the product is used.

9.2 Caution (Storage and operating condition):

Operating and storage environment

The insulating coating of capacitors does not form a perfect seal; therefore, do not use or store capacitors in a corrosive atmosphere, especially where chloride gas, sulfide gas, acid, alkali, salt or the like are present. And avoid exposure to moisture. Before cleaning, bonding, or molding this product, verify that these processes do not affect product quality by testing the performance of a cleaned, bonded or molded product in the intended equipment. Store the capacitors where the temperature and relative humidity do not exceed –10 to 40 degrees centigrade and 15 to 85 % for 6 months maximum and use within the period after receiving the capacitors.

"Failure to follow the above cautions may result, worst case, in a short circuit and cause fuming or partial dispersion when the product is used."

9.3 Caution (Soldering and Mounting):

9.3.1 Vibration and impact:

Do not expose a capacitor or its leads to excessive shock or vibration during use.

9.3.2 Soldering

When soldering this product to a PCB/PWB, do not exceed the solder heat resistance specification of the capacitor. Subjecting this product to excessive heating could melt the internal junction solder and may result in thermal shocks that can crack the ceramic element.

When soldering capacitor with a soldering iron, it should be performed in following conditions.

Temperature of iron-tip: 400 degrees C. max.

Soldering iron wattage: 50W max.

Soldering time: 3.5 sec. max.

9.3.3 Cleaning (ultrasonic cleaning):

To perform ultrasonic cleaning, observe the following conditions.

Rinse bath capacity: Output of 20 watts per liter or less.

Rinsing time:5 min maximum.

Do not vibrate the PCB/PWB directly.

Excessive ultrasonic cleaning may lead to fatigue destruction of the lead wires.

"Failure to follow the above cautions may result, worst case, in a short circuit and cause fuming or partial dispersion when the product is used."

9.4 Caution (Handling):

Vibration and impact

Do not expose a capacitor or its leads to excessive shock or vibration during use.

"Failure to follow the above cautions may result, worst case, in a short circuit and cause fuming or partial dispersion when the product is used."

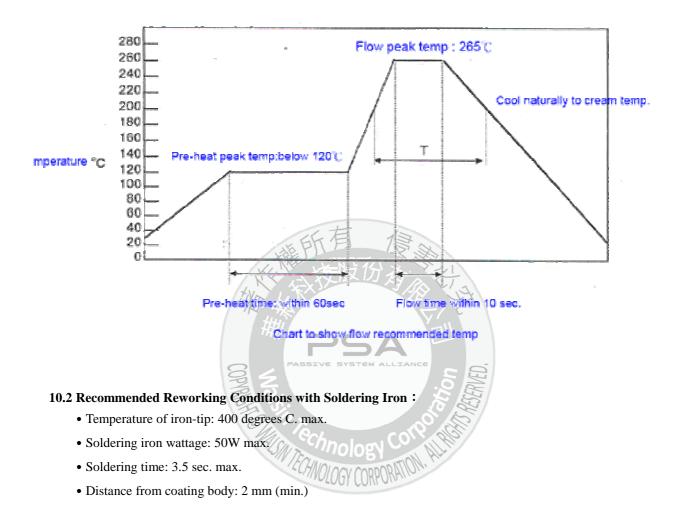
POE-D10-00-E-22

Ver: 22

10. Soldering Recommendation:

10.1 Wave Soldering Profile:

- Temperature conditions of the flow is recommended as shown in the chart
- Must implement the pre-heat
- Maximum peak flow temperature is recommended $265^{\circ}C$
- Time "T" implement in the chart recommended within 20 sec. it temperature exceed 200°C
- Take care with the flow solder not to touch the capacitor body directly at mounting



10.3 Reflow-Soldering : Lead Ceramic Cap. should not be soldered by reflow-soldering.

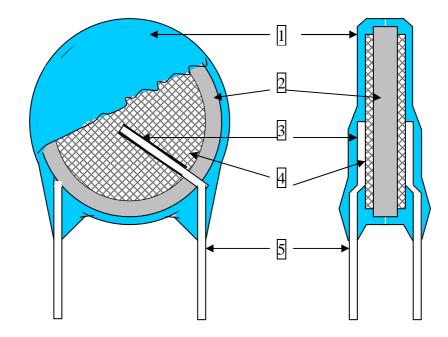
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Page: 19 / 19

Ver: 22

11. Drawing of internal structure and material list:



Remarks :

No.	Part name	Material	Model/Type	Component		
1	Insulation Coating	Epoxy polymer	EF-150 PCE-300 ECP-357	Epoxy resin、Pigment (Blue / UL 94 V-0) The minimum thickness of coating (reinforced insulation) is 0.4mm		
2	Dielectric Element	Ceramic	SL/Y5P/Y5U/Y5V	BaTiO ₃		
3	Solder	Tin-silver	Sn96.5-Ag3-Cu0.5	Sn96.5-Ag3-Cu0.5		
4	Electrodes	Ag	SP-160PL SP-260PL	Silver Glass frit		
5	Leads wire	Tinned copper clad steel wire	0.55±0.05mm	Substrate metal: Fe & Cu Surface plating: Sn 100%(3~7µm)		
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